ALUMINUM ELECTROLYTIC CAPACITORS







- Corresponding with 260°C peak reflow soldering Recomended reflow condition: 260°C peak 5 sec. 230°C over 60 sec.
- Chip type with 5.5mm height.
- Designed for surface mounting on high density PC board.
- Applicable to automatic mounting machine fed with carrier tape.
- Load life of 2000 hours at 85°C
- Compliant to the RoHS directive (2011/65/EU).



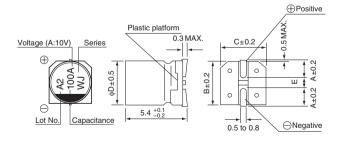




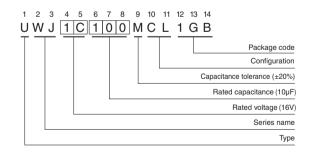
■Specifications

Item	Performance Characteristics											
Category Temperature Range	-40 to +85°C											
Rated Voltage Range	6.3 to 50V											
Rated Capacitance Range	0.1 to 150μF											
Capacitance Tolerance	±20% at 120Hz, 20°C											
Leakage Current	After 2 minutes' app	olication c	of rated vo	ltage, lea	kage c	urrent i	is not	more tl	han 0.01CV	' or 3 (μA)	,whichever is greater.	
				Mea	surem	ent freq	quency	: 120H	z at 20°C			
Tangent of loss angle (tan δ)	Rated voltage (V)	6.3	10	16	:	25	35	i	50			
	tan δ (MAX.)	0.26	0.20	0.16	0	.14	0.1	2	0.12			
	Measurement frequency : 120Hz											
	Rated voltage (V)			6.3	10	16	6	25	35	50		
Stability at Low Temperature	Impedance ratio	Z-25°C /	Z+20°C	4	3	2	2	2	2	2		
	ZT / Z20 (MAX.)	Z-40°C /	Z+20°C	8	8	4	1	4	3	3		
	The specifications li	Ca	Capacitance ch			nange Within ±20% of the initial capacitance value						
Endurance	when the capacitors are restored to 20°C after					tan δ					e initial specified value	
	the rated voltage is applied for 2000 hours at 85°C.						Curre				· .	
Shelf Life	After storing the capacitors under no load at 85°C for 1000 hours and then performing voltage treatment based on JIS C 5101-4 clause 4.1 at 20°C, they shall meet the specified values for the endurance characteristics listed above.											
	The capacitors are kept on a hot plate for 30 seconds, which is						is	Capacitance change		nge With	n ±10% of the initial capacitance value	
Resistance to soldering		maintained at 250°C. The capacitors shall meet the						tan δ		0	Less than or equal to the initial specified value	
heat	characteristic requirements listed at right when they are removed from the plate and restored to 20°C.										than or equal to the initial specified value	
Marking	Black print on the case top.											

■Chip Type



Type numbering system (Example: 16V 10µF)



Voltage						
V	6.3	10	16	25	35	50
Code	j	Α	С	Е	٧	Н

			(mm)		
φD	4	5	6.3		
Α	1.8	2.1	2.4		
В	4.3	5.3	6.6		
С	4.3	5.3	6.6		
E	1.0	1.3	2.2		



■Dimensions

V		6.3		10		16		25		35		50	
Cap. (µF)	Code	0	J	1A		1C		1E		1V		1H	
0.1	0R1				 		 		 			4	1.0
0.22	R22				1				 			4	2.0
0.33	R33				i		İ					4	2.8
0.47	R47				 		 		l I			4	4.0
1	010				 		1		 			4	8.4
2.2	2R2				i i		i					4	13
3.3	3R3				I I		1					4	17
4.7	4R7				 		1	4	16	4	18	5	20
10	100					4	23	5	27	5	29	6.3	33
22	220	4	28	5	33	5	37	6.3	42	6.3	45		
33	330	5	37	5	41	6.3	49	6.3	52				
47	470	5	45	6.3	52	6.3	58		 				
100	101	6.3	70	6.3	76	6.3	86					Case size	Rated
150	151	6.3	71									φD (mm)	ripple

Rated ripple current (mArms) at 85°C 120Hz

• Frequency coefficient of rated ripple current

Frequency	50 Hz	120 Hz	300 Hz	1 kHz	10 kHz or more	
Coefficient	0.70	1.00	1.17	1.36	1.50	

- Taping specifications are given in page 23.
- Recommended land size, soldering by reflow are given in page 18, 19.
- Please refer to page 3 for the minimum order quantity.